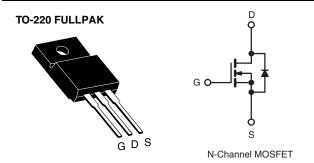
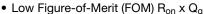


E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.28		
Q _g max. (nC)	76			
Q _{gs} (nC)	11			
Q _{gd} (nC)	17			
Configuration	Single			



FEATURES







· Reduced Switching and Conduction Losses

- Ultra Low Gate Charge (Q_q)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION			
Package	TO-220 FULLPAK		
Lead (Pb)-free	SiHF15N60E-E3		

ABSOLUTE MAXIMUM RATINGS (T	$_{\rm C}$ = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	600	
Gate-Source Voltage			V _{GS}	± 20	V
Gate-Source Voltage AC (f > 1 Hz)				30	
Continuous Drain Current (T _J = 150 °C) ^e	V at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	15	А
	V _{GS} at 10 V	T _C = 100 °C		9.6	
Pulsed Drain Current ^a			I _{DM}	39	
Linear Derating Factor				0.27	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	102	mJ
Maximum Power Dissipation			P_{D}	34	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C
Drain-Source Voltage Slope	$T_{J} = 1$	T _J = 125 °C		37	V/ns
Reverse Diode dV/dt ^d		dV/dt	7.7	V/115	
Soldering Recommendations (Peak Temperature)	for	for 10 s		300°	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=11.6 mH, $R_g=25$ Ω , $I_{AS}=4.2$ A.
- 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.
- e. Limited by maximum junction temperature.



Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	65	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	3.7	C/VV		

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static				•	•		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V		-	± 100	nA
		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	μА
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8 A	-	0.23	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS}	V _{DS} = 30 V, I _D = 8 A		4.6	-	S
Dynamic						I	
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	1350	-	-
Output Capacitance	C _{oss}			-	70	-	
Reverse Transfer Capacitance	C _{rss}			-	5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	53	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	177	-	
Total Gate Charge	Qg			-	38	76	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 8 \text{ A}, V_{DS} = 480 \text{ V}$		11	-	nC
Gate-Drain Charge	Q _{gd}			-	17	-	1
Turn-On Delay Time	t _{d(on)}			-	17	34	
Rise Time	t _r	V_{DD} = 480 V, I_D = 8 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	51	77	ns
Turn-Off Delay Time	$t_{d(off)}$			-	35	70	
Fall Time	t _f			-	33	66	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.86	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	
Pulsed Diode Forward Current	I _{SM}			-	-	60	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 8 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 20 \text{ V}$		-	410	-	ns
Reverse Recovery Charge	Q _{rr}			_	5.4	-	μC
Reverse Recovery Current	I _{RRM}			_	21	_	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

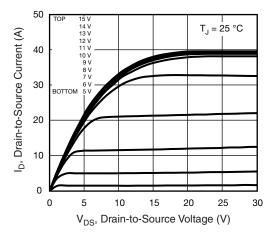


Fig. 1 - Typical Output Characteristics

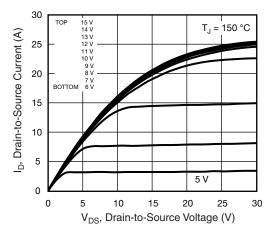


Fig. 2 - Typical Output Characteristics

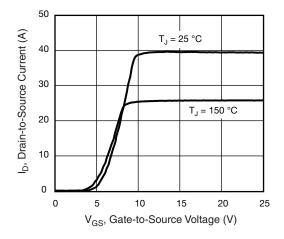


Fig. 3 - Typical Transfer Characteristics

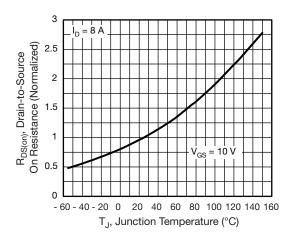


Fig. 4 - Normalized On-Resistance vs. Temperature

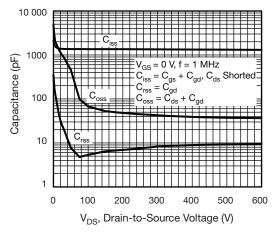


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

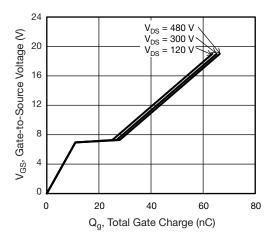


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



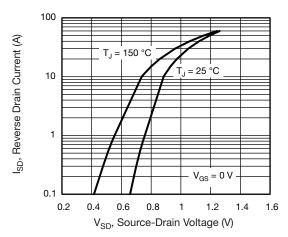


Fig. 7 - Typical Source-Drain Diode Forward Voltage

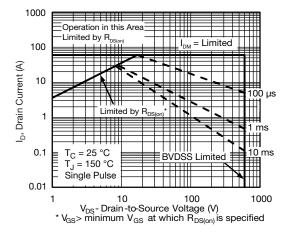


Fig. 8 - Maximum Safe Operating Area

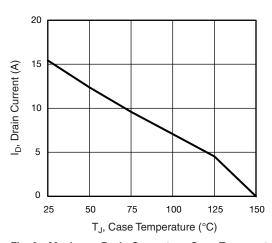


Fig. 9 - Maximum Drain Current vs. Case Temperature

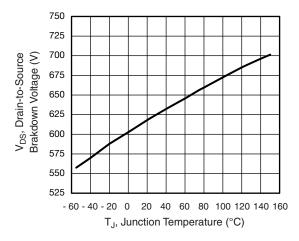


Fig. 10 - Temperature vs. Drain-to-Source Voltage

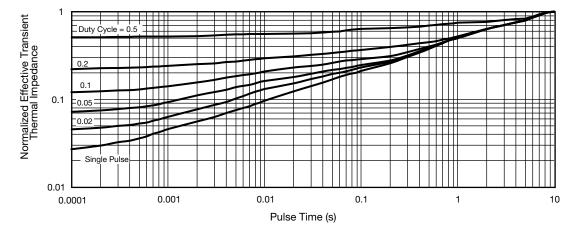


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



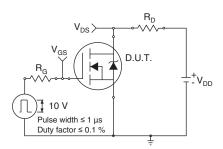


Fig. 12 - Switching Time Test Circuit

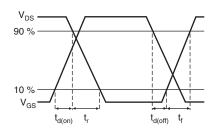


Fig. 13 - Switching Time Waveforms

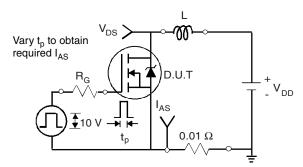


Fig. 14 - Unclamped Inductive Test Circuit

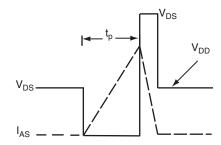


Fig. 15 - Unclamped Inductive Waveforms

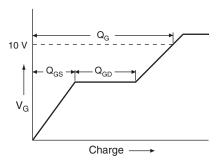


Fig. 16 - Basic Gate Charge Waveform

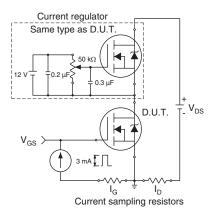
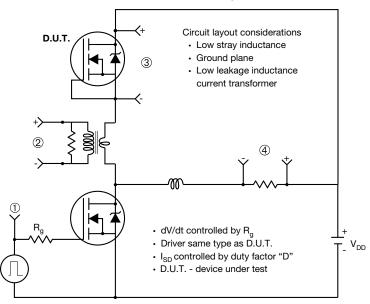


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



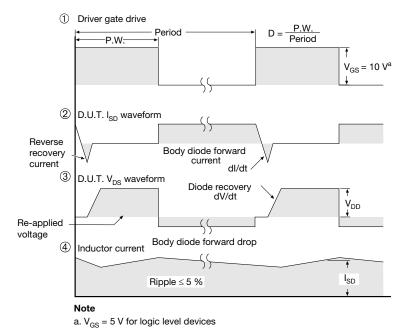


Fig. 18 - For N-Channel

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